DATA SHEET



GaAs INTEGRATED CIRCUIT μ PG2404T6Q

L-BAND SP3T SWITCH

DESCRIPTION

The μ PG2404T6Q is an L-band SP3T GaAs FET switch which was developed for CDMA/PCS/GPS triple mode digital cellular telephone application.

This device can operate frequency from 10 MHz to 2.0 GHz, having the low insertion loss and high isolation.

This device is housed in a 10-pin plastic TSSON (<u>Thin Shrink Small Out-line Non-leaded</u>) package. And this package is able to high-density surface mounting.

FEATURES

• Low insertion loss : Lins = 0.45 dB TYP. @ f = 1.0 GHz, $V_{\text{cont (H)}} = 2.8 \text{ V}$, $V_{\text{cont (L)}} = 0 \text{ V}$

: Lins = 0.55 dB TYP. @ f = 2.0 GHz, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V

• High isolation : ISL = 21 dB TYP. @ f = 2.0 GHz, $V_{cont}(H) = 2.8$ V, $V_{cont}(L) = 0$ V

High power
 Pin (0.1 dB) = +33.0 dBm TYP. @ f = 1.0 GHz, Vcont (H) = 2.8 V, Vcont (L) = 0 V

• High-density surface mounting : 10-pin plastic TSSON package ($2.0 \times 1.35 \times 0.37$ mm)

APPLICATIONS

- CDMA/PCS/GPS triple mode digital cellular telephone etc.
- NFC (FeliCa[™] etc.)

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2404T6Q-E2	μPG2404T6Q-E2-A	10-pin plastic TSSON (Pb-Free)	G5H	Embossed tape 8 mm wide Pin 5, 6 face the perforation side of the tape Qty 3 kpcs/reel

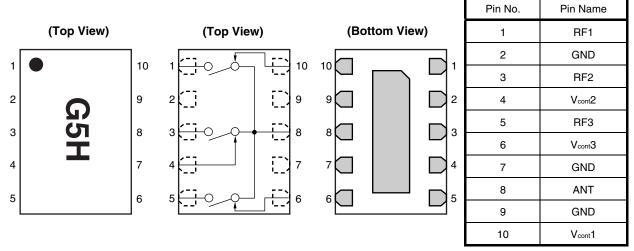
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: μPG2404T6Q

Caution Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Remark Exposed pad: GND

TRUTH TABLE

V _{cont} 1	V _{cont} 2	V _{cont} 3	ANT-RF1	ANT-RF2	ANT-RF3
High	Low	Low	ON	OFF	OFF
Low	High	Low	OFF	ON	OFF
Low	Low	High	OFF	OFF	ON

ABSOLUTE MAXIMUM RATINGS (Ta = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	+6.0 Note	V
Input Power	Pin	+36	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note $|V_{cont (H)} - V_{cont (L)}| \le 6.0 \text{ V}$

RECOMMENDED OPERATING RANGE ($T_A = +25$ °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	V _{cont (H)}	2.7	2.8	3.0	V
Switch Control Voltage (L)	V _{cont (L)}	-0.2	0	0.2	V

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ELECTRICAL CHARACTERISTICS

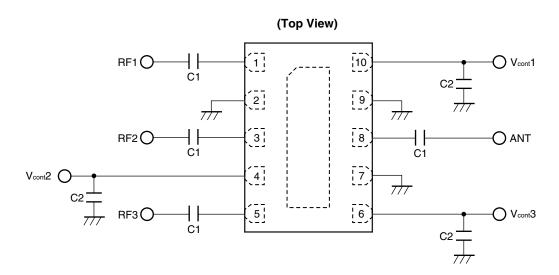
(TA = +25°C, V_{cont} (H) = 2.8 V, V_{cont} (L) = 0 V, Z_{O} = 50 Ω , DC blocking capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Pass	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins	ANT to RF1, 2, 3	f = 0.5 to 1.0 GHz	-	0.45	0.65	dB
			f = 1.0 to 2.0 GHz	1	0.55	0.80	dB
Isolation	ISL	ANT to RF1, 2, 3	f = 0.5 to 1.0 GHz	22	26	1	dB
		(OFF)	f = 1.0 to 2.0 GHz	17	21	1	dB
Input Return Loss	RLin	ANT to RF1, 2, 3	f = 0.5 to 2.0 GHz	15	20	1	dB
Output Return Loss	RLout	ANT to RF1, 2, 3	f = 0.5 to 2.0 GHz	15	20	1	dB
0.1 dB Loss Compression Input Power Note	Pin (0.1 dB)	ANT to RF1, 2, 3	f = 1.0 GHz	+31.0	+33.0	-	dBm
2nd Harmonics	2fo	ANT to RF1, 2, 3	f = 1.0 GHz, P _{in} = 27 dBm	65	75	-	dBc
3rd Harmonics	3fo	ANT to RF1, 2, 3	f = 1.0 GHz, P _{in} = 27 dBm	65	75	_	dBc
Switch Control Current	Icont		RF None	-	1	50	μΑ
Switch Control Speed	tsw				150		ns

Note P_{in (0.1 dB)} is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

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EVALUATION CIRCUIT

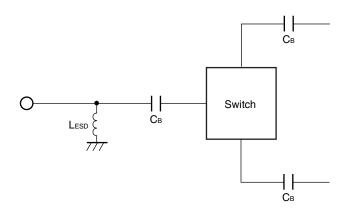


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

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Symbol	Values		
C1	56 pF		
C2	1 000 pF		

APPLICATION INFORMATION



• CB are DC blocking capacitors external to the device.

A value of 56 pF is sufficient for operation from 500 MHz to 2.5 GHz bands.

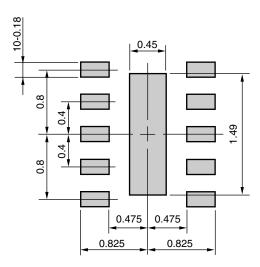
The value may be tailored to provide specific electrical responses.

- The RF ground connections should be kept as short as possible and connected to directly to a good RF ground for best performance.
- Lesp provides a means to increase the ESD protection on a specific RF port, typically the port attached to the antenna.

MOUNTING PAD LAYOUT DIMENSIONS

10-PIN PLASTIC TSSON (UNIT: mm)

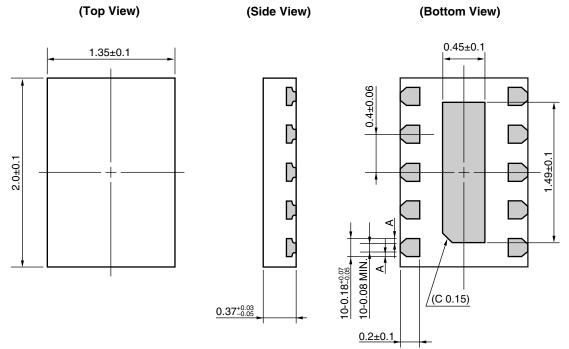
MOUNTING PAD



Remark The mounting pad layout in this document is for reference only.

PACKAGE DIMENSIONS

10-PIN PLASTIC TSSON (UNIT: mm)



Remark A>0

(): Reference value

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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FeliCa is the contactless IC card technology developed by Sony Corporation. FeliCa is a trademark of Sony Corporation.

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M8E 02.11-1

NEC μ PG2404T6Q

ITION	

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.